



WLCSP8, 1.16x1.16 CASE 567CE ISSUE O

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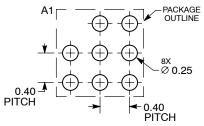


NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. COPLANARITY APPLIES TO SPHERICAL

CROV	VNS OF S	1	
	MILLIN		

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.57	0.63	
A1	0.17	0.24	
A2	0.41 REF		
b	0.24	0.29	
D	1.16 BSC		
E	1.16 BSC		
٥	0.40 BSC		

## RECOMMENDED SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PIN A1 REFERENCE	D A B
2X  0.05  C  TOP	VIEW
0.05 C V O.05 C NOTE 3 A1 SIDE	A2 A A C SEATING PLANE
8X Ø b  0.05 C A B C  0.03 C B  A  1	e e e v 2 3

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